

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	B88069X9851T702
Manufacturer:	TDK
Package:	Tape & Reel (TR), Cut Tape (CT)
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/tdk/b88069x9851t702.html>

Request a Quote:

[Submit RFQ for this part](#)



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Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.



Surge arrester

2-electrode arrester

Series/Type:	EN230XSMD
Ordering code:	B88069X9851T702
Date:	2026-04-01
Version:	03

Surge arrester

B88069X9851T702

2-electrode arrester

EN230XSMD

Features

- Very small size
- Very fast response time
- Stable performance over life
- Very low capacitance
- High insulation resistance
- Excellent SMD handling
- RoHS-compatible

Applications

- Modem
- XDSL-splitter
- Consumer electronic
- Tuner

Electrical specifications

DC spark-over voltage ^{1) 2)}	230	V
Tolerance	±20	%
Min.	184	V
Max.	276	V
Impulse spark-over voltage		
at 100 V/μs - for 99% of measured values	< 500	V
- typical values of distribution	< 400	V
at 1 kV/μs - for 99% of measured values	< 650	V
- typical values of distribution	< 550	V
Service life		
10 operations 50 Hz, 1 s	5	A
1 operation 50 Hz, 0.18 s (9 cycles)	20	A
10 operations [5× (+) & 5× (-)] 8/20 μs	5	kA
1 operation 10/350 μs	1.5	kA
300 operations [150× (+) & 150× (-)] 10/1000 μs	100	A
DC hold-over voltage		
at 135 V _{DC} / 1300 Ω	< 150	ms
Insulation resistance at 100 V _{DC}	> 1	GΩ
Capacitance at 1 MHz	< 1	pF
Arc voltage at 1 A	~ 15	V
Glow to arc transition current	< 0.5	A
Glow voltage	~ 140	V
Weight	~ 0.5	g
Operation and storage temperature	-40 ... +125	°C
Climatic category (IEC 60068-1)	40/125/21	
Marking, blue positive	TDK EN 230 YY EN - Series 230 - Nominal voltage YY - Year of production	
Certification	UL 497B (E163070)	

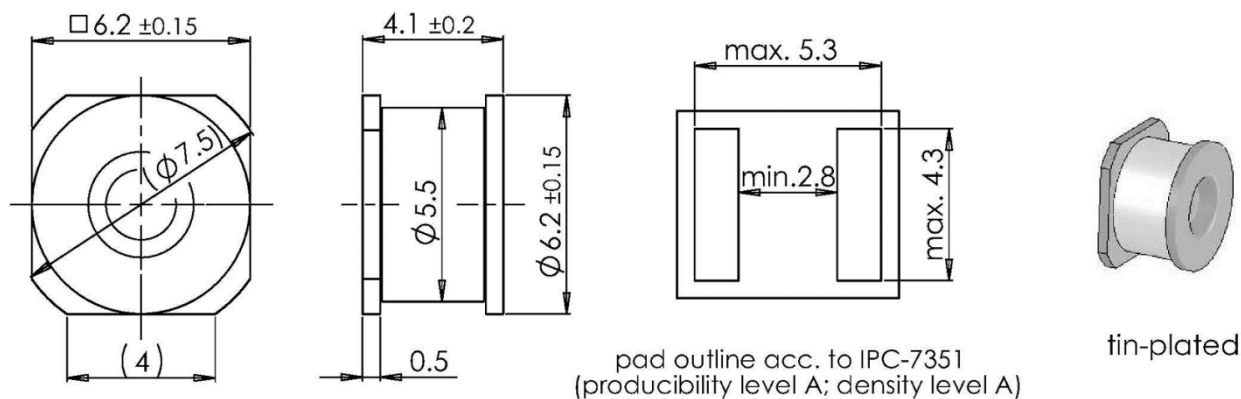
Remarks on next page

1) At delivery AQL 0.65 level II, DIN ISO 2859

2) In ionized mode

Terms in accordance with ITU-T Rec. K.12 and IEC 61643-311.

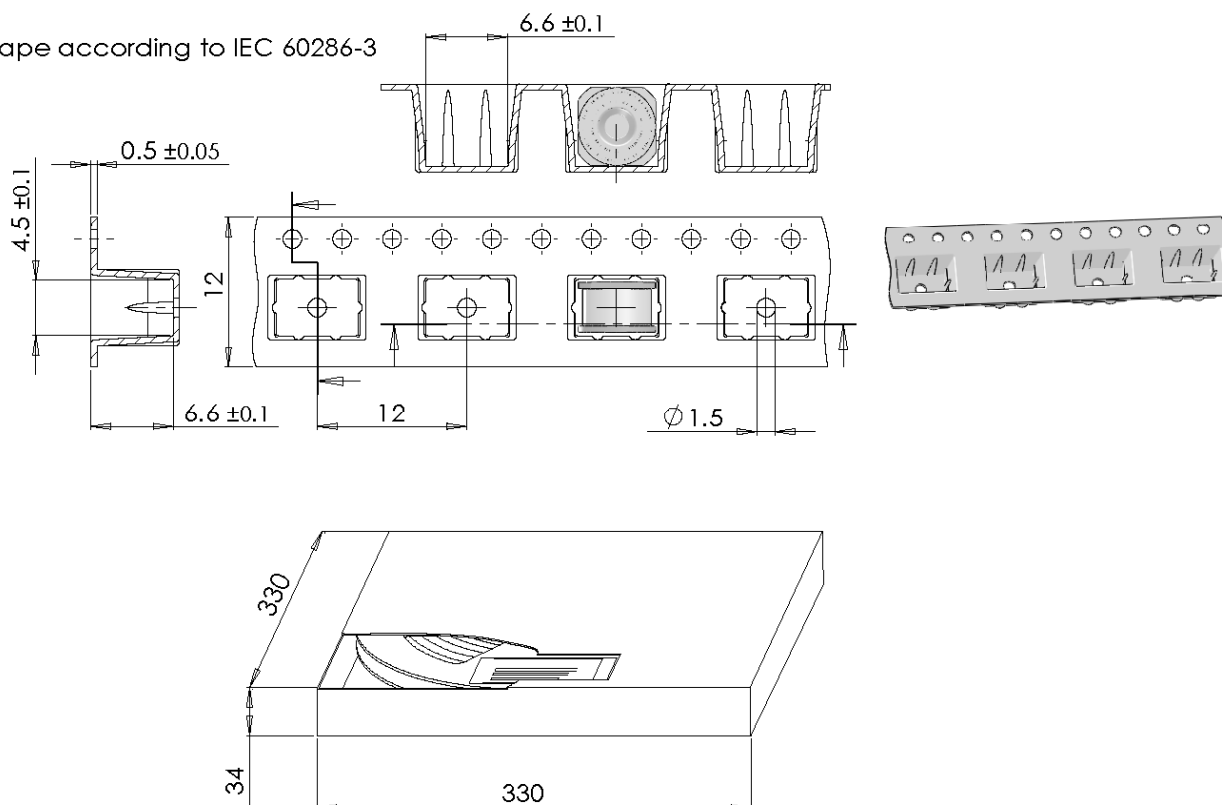
Dimensional drawing in mm



Ordering codes and packing advices

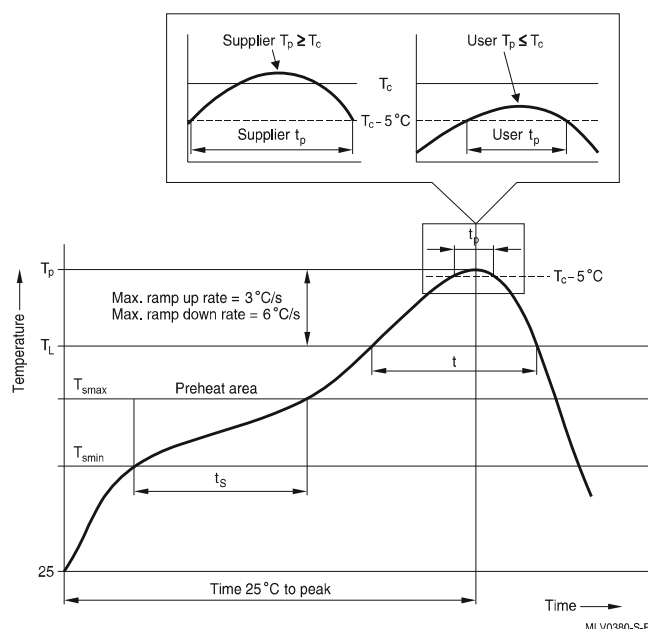
B88069X9851T702 = 700 pcs. on SMD-tape & reel

SMD-tape according to IEC 60286-3



Soldering parameter

Reflow soldering



Reflow profile features		Sn- Pb eutectic assembly	Pb-free assembly
Preheat and soak - Temperature min - Temperature max - Time	T_{smin} T_{smax} t_{smin} to t_{smax}	100 °C 150 °C 60 ... 120 s	150 °C 200 °C 60 ... 180 s
Average ramp-up rate	T_{smax} to T_p	max. 3 °C/ s	max. 3 °C/ s
Liquidous temperature Time at liquidous	T_L t_L	183 °C 60 ... 150 s	217 °C 60 ... 150 s
Peak package body temperature *, Classification temperature **	T_p , T_c	220 ... 235 °C **	245 ... 260 °C **
Time (t_p) ** within 5 °C of the specified classification temperature (T_c)		20 s ***	30 s ***
Average ramp-down rate	T_p to T_{smax}	max. 6 °C/ s	max. 6 °C/ s
Time 25 °C to peak temperature		max. 6 min	max. 8 min

* = Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.
 ** = For details please refer to JEDEC J-STD-020D.
 *** = Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

Cautions and warnings

- Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- Surge arresters must be handled with care and must not be dropped.
- Do not continue to use damaged surge arresters.
- The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- SMD surge arresters should be soldered within 24 month after shipment.

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1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
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Important notes

8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, FilterCap, FormFit, InsuGate, LeaXield, MediPlas, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PiezoBrush, PlasmaBrush, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SurfIND, ThermoFuse, WindCap, XieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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